



## SN74AHCT1G04 Single Inverter Gate

### 1 Features

- Operating Range 4.5-V to 5.5-V
- Max  $t_{pd}$  of 7.5 ns at 5-V
- Low Power Consumption, 10- $\mu$ A Max  $I_{CC}$
- $\pm 8$ -mA Output Drive at 5-V
- Inputs are TTL-Voltage Compatible
- Latch-Up Performance Exceeds 250 mA Per JESD 17

### 2 Applications

- Notebook PCs
- Electronic Points of Sale
- Patient Monitoring
- Motor Controls: AC Induction
- Network Switches
- Tests

### 3 Description

The SN74AHCT1G04 contains one gate. The device performs the Boolean function  $Y = \bar{A}$ .

#### Device Information<sup>(1)</sup>

| PART NUMBER  | PACKAGE    | BODY SIZE (NOM)   |
|--------------|------------|-------------------|
| SN74AHCT1G04 | SOT-23 (5) | 2.90 mm x 1.60 mm |
|              | SC-70 (5)  | 2.00 mm x 1.30 mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

### 4 Simplified Schematic



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## 5 Revision History

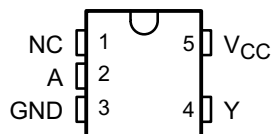
### Changes from Revision O (October 2013) to Revision P

Page

|  |          |
|--|----------|
| • Added <i>Applications</i> , <i>Device Information</i> table, <i>Pin Functions</i> table, <i>ESD Ratings</i> table, <i>Thermal Information</i> table, <i>Typical Characteristics</i> , <i>Feature Description</i> section, <i>Device Functional Modes</i> , <i>Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section. .... | <b>1</b> |
| • Deleted <i>Ordering Information</i> table. ....  | <b>1</b> |
| • Changed MAX operating temperature to 125°C in <i>Recommended Operating Conditions</i> table. ....  | <b>4</b> |

## 6 Pin Configuration and Functions

**DBV OR DCK PACKAGE  
(TOP VIEW)**



NC – No internal connection

**Pin Functions**

| PIN |                 | TYPE | DESCRIPTION   |
|-----|-----------------|------|---------------|
| NO. | NAME            |      |               |
| 1   | NC              | —    | No Connection |
| 2   | A               | I    | Input A       |
| 3   | GND             | —    | Ground Pin    |
| 4   | Y               | O    | Output Y      |
| 5   | V <sub>CC</sub> | —    | Power Pin     |

## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                  |   | MIN  | MAX                   | UNIT |
|------------------|---|--|-----------------------|------|
| V <sub>CC</sub>  | Supply voltage range                              | −0.5   | 7                     | V    |
| V <sub>I</sub>   | Input voltage range <sup>(2)</sup>                | −0.5   | 7                     | V    |
| V <sub>O</sub>   | Output voltage range <sup>(2)</sup>               | −0.5   | V <sub>CC</sub> + 0.5 | V    |
| I <sub>IK</sub>  | Input clamp current                               | V <sub>I</sub> < 0                                     | −20                   | mA   |
| I <sub>OK</sub>  | Output clamp current                              | V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> | ±20                   | mA   |
| I <sub>O</sub>   | Continuous output current                         | V <sub>O</sub> = 0 to V <sub>CC</sub>                  | ±25                   | mA   |
|                  | Continuous current through V <sub>CC</sub> or GND |  | ±50                   | mA   |
| T <sub>stg</sub> | Storage temperature range                         | −65  | 150                   | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*<sup>(1)</sup> is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

### 7.2 ESD Ratings

|                    |                         | VALUE  | UNIT |
|--------------------|-------------------------|--|------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>              | 1500 |
|                    |                         | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup> | 1000 |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions<sup>(1)</sup>

|                 |                                    | MIN | MAX             | UNIT |
|-----------------|------------------------------------|-----|-----------------|------|
| V <sub>CC</sub> | Supply voltage                     | 4.5 | 5.5             | V    |
| V <sub>IH</sub> | High-level input voltage           | 2   |                 | V    |
| V <sub>IL</sub> | Low-level Input voltage            |     | 0.8             | V    |
| V <sub>I</sub>  | Input voltage                      | 0   | 5.5             | V    |
| V <sub>O</sub>  | Output voltage                     | 0   | V <sub>CC</sub> | V    |
| I <sub>OH</sub> | High-level output current          |     | −8              | mA   |
| I <sub>OL</sub> | Low-level output current           |     | 8               | mA   |
| Δt/Δv           | Input Transition rise or fall rate |     | 20              | ns/V |
| T <sub>A</sub>  | Operating free-air temperature     | −40 | 125             | °C   |

- (1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs* (SCBA004)

### 7.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |  | SN74AHCT1G04 |       | UNIT |
|-------------------------------|--|--------------|-------|------|
|                               |  | DBV          | DCK   |      |
|                               |  | 5 PINS       |       |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 231.3        | 287.6 | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 119.9        | 97.7  |      |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 60.6         | 65.   |      |
| ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 17.8         | 2.0   |      |
| ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 60.1         | 64.2  |      |

- (1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report (SPRA953).

## 7.5 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

| PARAMETER             | TEST CONDITIONS                                     | $V_{CC}$     | $T_A = 25^\circ\text{C}$ |     |           | $-40^\circ\text{C to } 85^\circ\text{C}$ |         | $-40^\circ\text{C to } 125^\circ\text{C}$ |         | UNIT          |
|-----------------------|---|--------------|--------------------------|-----|-----------|--|---------|---|---------|---------------|
|                       |   |              | MIN                      | TYP | MAX       | MIN                                      | MAX     | MIN                                       | MAX     |               |
| $V_{OH}$              | $I_{OH} = -50\text{ }\mu\text{A}$                   | 4.5 V        | 4.4                      | 4.5 |           | 4.4                                      |         | 4.4                                       |         | V             |
|                       | $I_{OH} = -8\text{ mA}$                             |              | 3.94                     |     |           | 3.8                                      |         | 3.8                                       |         |               |
| $V_{OL}$              | $I_{OL} = 50\text{ }\mu\text{A}$                    | 4.5 V        |                          |     | 0.1       |  | 0.1     |   | 0.1     | V             |
|                       | $I_{OL} = 8\text{ mA}$                              |              |                          |     | 0.36      |  | 0.44    |   | 0.44    |               |
| $I_I$                 | $V_I = 5.5\text{ V or GND}$                         | 0 V to 5.5 V |                          |     | $\pm 0.1$ |  | $\pm 1$ |   | $\pm 1$ | $\mu\text{A}$ |
| $I_{CC}$              | $V_I = V_{CC}$ or $\text{GND}_I$ , $I_O = 0$        | 5.5 V        |                          |     | 1         |  | 10      |   | 10      | $\mu\text{A}$ |
| $\Delta I_{CC}^{(1)}$ | One input at 3.4 V, Other Inputs at $V_{CC}$ or GND | 5.5 V        |                          |     | 1.35      |  | 1.5     |   | 1.5     | mA            |
| $C_i$                 | $V_I = V_{CC}$ or GND                               | 5 V          |                          | 4   |           |  | 10      |   | 10      | pF            |

(1) This is the increase in supply current for each input at one of the specified TTL voltage levels, rather than 0 V or  $V_{CC}$ .

## 7.6 Switching Characteristics

over recommended operating free-air temperature range,  $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$  (unless otherwise noted) (see Figure 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | OUTPUT CAPACITANCE   | $T_A = 25^\circ\text{C}$ |     | $-40^\circ\text{C to } 85^\circ\text{C}$ |     | $-40^\circ\text{C to } 125^\circ\text{C}$ |     | UNIT |
|-----------|--------------|-------------|----------------------|--------------------------|-----|--|-----|---|-----|------|
|           |              |             |                      | TYP                      | MAX | MIN                                      | MAX | MIN                                       | MAX |      |
| $t_{PLH}$ | A or B       | Y           | $C_L = 15\text{ pF}$ | 4.7                      |     | 1  | 7.5 | 1   | 8   | ns   |
| $t_{PHL}$ |              |             |                      | 4.7                      |     | 1  | 7.5 | 1   | 8   |      |
| $t_{PLH}$ | A or B       | Y           | $C_L = 50\text{ pF}$ | 5.5                      |     | 1  | 8.5 | 1   | 9   | ns   |
| $t_{PHL}$ |              |             |                      | 5.5                      |     | 1  | 8.5 | 1   | 9   |      |

## 7.7 Operating Characteristics

$V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$

| PARAMETER |                               | TEST CONDITIONS             | TYP | UNIT |
|-----------|-------------------------------|-----------------------------|-----|------|
| $C_{pd}$  | Power dissipation capacitance | No load, $f = 1\text{ MHz}$ | 14  | pF   |

## 7.8 Typical Characteristics

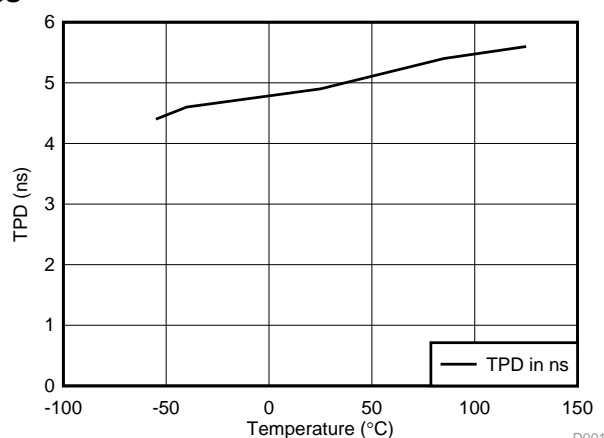
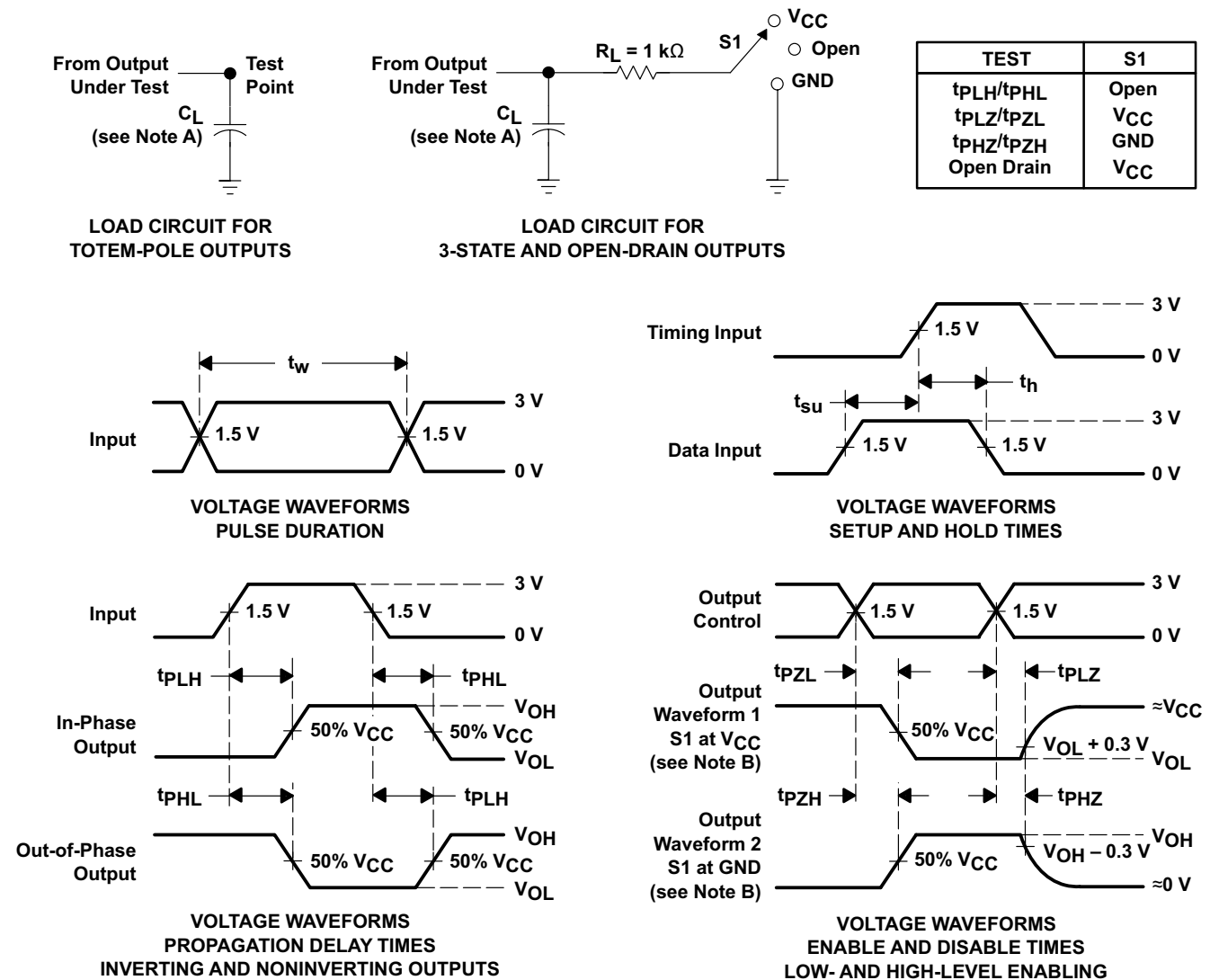


Figure 1. TPD vs Temperature

## 8 Parameter Measurement Information



- A.  $C_L$  includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.  
Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 3\text{ ns}$ ,  $t_f \leq 3\text{ ns}$ .
- D. The outputs are measured one at a time with one input transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

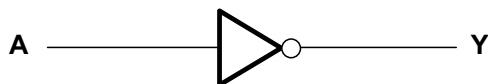
**Figure 2. Load Circuit And Voltage Waveforms**

## 9 Detailed Description

### 9.1 Overview

The SN74AHCT1G04 device contains one inverter. This device has TTL input levels that allow up translation from 3.3 V to 5 V.

### 9.2 Functional Block Diagram



**Figure 3. Logic Diagram (Positive Logic)**

### 9.3 Feature Description

- $V_{CC}$  is optimized at 5 V
- Allows up voltage translation from 3.3 V to 5 V
  - Inputs accept  $V_{IH}$  levels of 2 V
- Slow edge rates minimize output ringing
- Inputs are TTL-Voltage compatible

### 9.4 Device Functional Modes

**Table 1. Function Table**

| INPUT<br>A | OUTPUT<br>Y |
|------------|-------------|
| H          | L           |
| L          | H           |

## 10 Application and Implementation

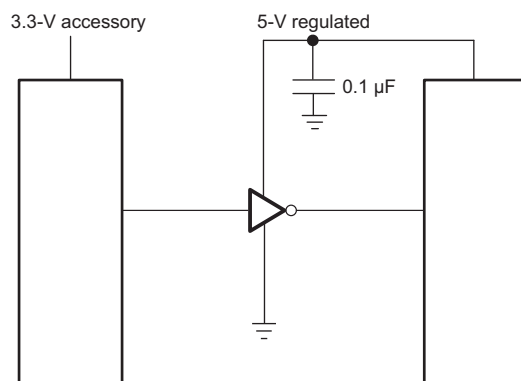
### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 10.1 Application Information

SN74AHCT1G04 is a low-drive CMOS device that can be used for a multitude of inverting type applications where output ringing is a concern. The low drive and slow edge rates will minimize overshoot and undershoot on the outputs. The input switching levels have been lowered to accommodate TTL inputs of 0.8 V  $V_{IL}$  and 2 V  $V_{IH}$ . This feature makes it ideal for translating up from 3.3 V to 5 V. [Figure 5](#) shows this type of translation.

### 10.2 Typical Application



**Figure 4. Typical Application Schematic**

#### 10.2.1 Design Requirements

This device uses CMOS technology and has balanced output drive. Care should be taken to avoid bus contention because it can drive currents that would exceed maximum limits. The high drive will also create fast edges into light loads, so routing and load conditions should be considered to prevent ringing.

#### 10.2.2 Detailed Design Procedure

1. Recommended Input Conditions
    - For rise time and fall time specifications, see  $\Delta t/\Delta V$  in the [Recommended Operating Conditions<sup>\(1\)</sup>](#) table.
    - For specified High and low levels, see  $V_{IH}$  and  $V_{IL}$  in the [Recommended Operating Conditions<sup>\(1\)</sup>](#) table.
    - Inputs are overvoltage tolerant allowing them to go as high as 5.5 V at any valid  $V_{CC}$ .
  2. Recommend Output Conditions
    - Load currents should not exceed 25 mA per output and 50 mA total for the part.
    - Outputs should not be pulled above  $V_{CC}$ .
- (1) All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, [Implications of Slow or Floating CMOS Inputs \(SCBA004\)](#)



## Typical Application (continued)

### 10.2.3 Application Curves

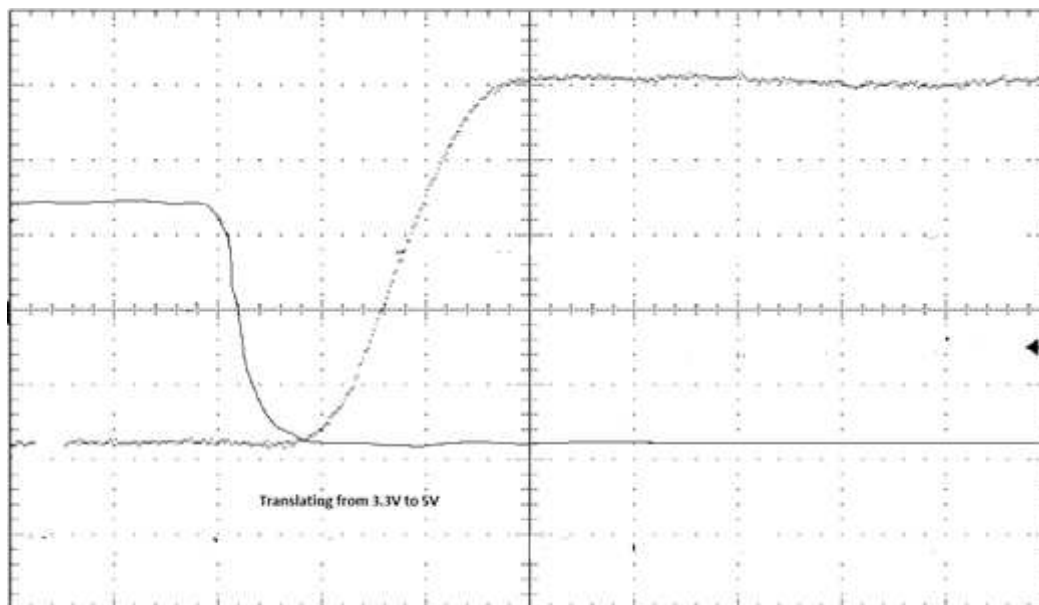


Figure 5. 3.3-V to 5-V Translation

## 11 Power Supply Recommendations

The power supply can be any voltage between the MIN and MAX supply voltage rating located in the [Recommended Operating Conditions<sup>\(1\)</sup>](#) table.

Each  $V_{CC}$  pin should have a good bypass capacitor to prevent power disturbance. For devices with a single supply, 0.1  $\mu\text{F}$  is recommended. If there are multiple  $V_{CC}$  pins, 0.01  $\mu\text{F}$  or 0.022  $\mu\text{F}$  is recommended for each power pin. It is acceptable to parallel multiple bypass caps to reject different frequencies of noise. A 0.1  $\mu\text{F}$  and 1  $\mu\text{F}$  are commonly used in parallel. The bypass capacitor should be installed as close to the power pin as possible for best results.

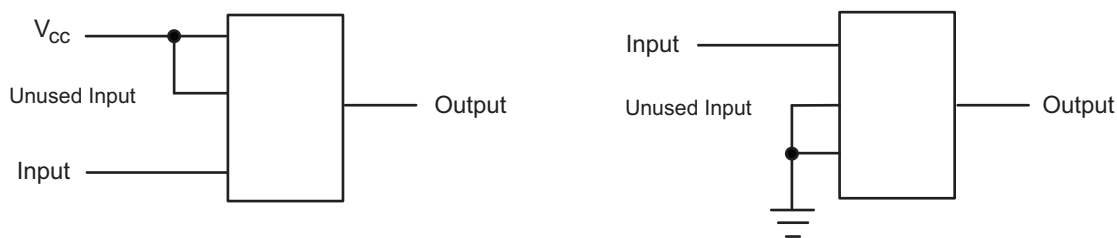
## 12 Layout

### 12.1 Layout Guidelines

When using multiple bit logic devices, inputs should not float. In many cases, functions or parts of functions of digital logic devices are unused. Some examples are when only two inputs of a triple-input AND gate are used, or when only 3 of the 4-buffer gates are used. Such input pins should not be left unconnected because the undefined voltages at the outside connections result in undefined operational states.

Specified in [Figure 6](#) are rules that must be observed under all circumstances. All unused inputs of digital logic devices must be connected to a high or low bias to prevent them from floating. The logic level that should be applied to any particular unused input depends on the function of the device. Generally they will be tied to GND or  $V_{CC}$ , whichever makes more sense or is more convenient. It is acceptable to float outputs unless the part is a transceiver. If the transceiver has an output enable pin, it will disable the outputs section of the part when asserted. This will not disable the input section of the I/Os so they also cannot float when disabled.

### 12.2 Layout Example



**Figure 6. Layout Diagram**

## 13 Device and Documentation Support

### 13.1 Trademarks

All trademarks are the property of their respective owners.

### 13.2 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 13.3 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5)           | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-----------------------------------|-------------------------|
| 74AHCT1G04DBVRE4 | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | B04G                              | <a href="#">Samples</a> |
| 74AHCT1G04DBVRG4 | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | B04G                              | <a href="#">Samples</a> |
| 74AHCT1G04DBVTG4 | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | B04G                              | <a href="#">Samples</a> |
| 74AHCT1G04DCKRE4 | ACTIVE        | SC70         | DCK                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | BC3                               | <a href="#">Samples</a> |
| 74AHCT1G04DCKRG4 | ACTIVE        | SC70         | DCK                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | BC3                               | <a href="#">Samples</a> |
| 74AHCT1G04DCKTG4 | ACTIVE        | SC70         | DCK                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | BC3                               | <a href="#">Samples</a> |
| SN74AHCT1G04DBVR | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU   CU SN       | Level-1-260C-UNLIM   | -40 to 125   | (B043, B04G, B04J,<br>B04L, B04S) | <a href="#">Samples</a> |
| SN74AHCT1G04DBVT | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU   CU SN       | Level-1-260C-UNLIM   | -40 to 125   | (B043, B04G, B04J,<br>B04L, B04S) | <a href="#">Samples</a> |
| SN74AHCT1G04DCKR | ACTIVE        | SC70         | DCK                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU   CU SN       | Level-1-260C-UNLIM   | -40 to 125   | (BC3, BCG, BCJ, BC<br>L, BCS)     | <a href="#">Samples</a> |
| SN74AHCT1G04DCKT | ACTIVE        | SC70         | DCK                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU   CU SN       | Level-1-260C-UNLIM   | -40 to 125   | (BC3, BCG, BCJ, BC<br>L, BCS)     | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

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**OTHER QUALIFIED VERSIONS OF SN74AHCT1G04 :**

- Automotive: [SN74AHCT1G04-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

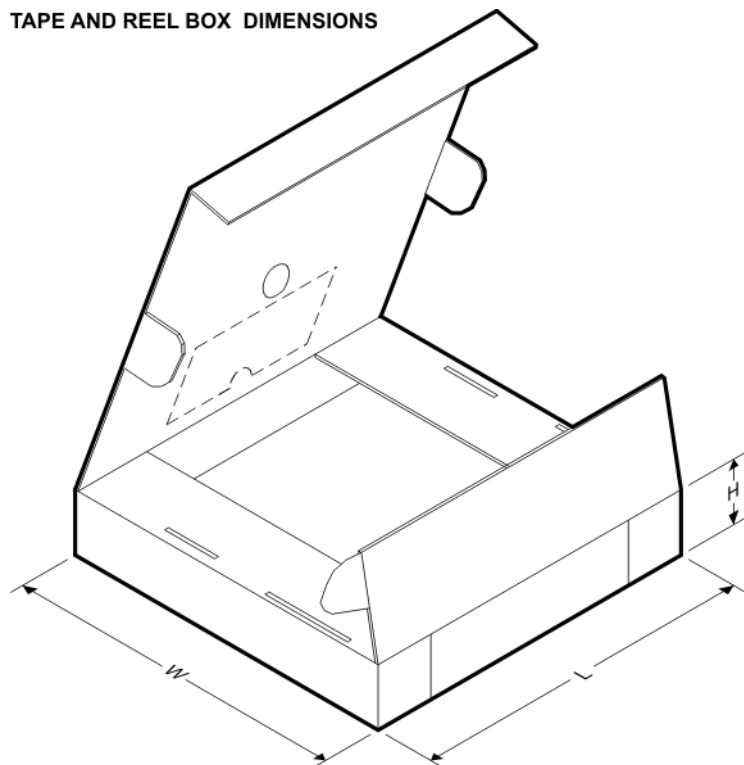
**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| 74AHCT1G04DBVRG4 | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| 74AHCT1G04DBVTG4 | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| 74AHCT1G04DCKRG4 | SC70         | DCK             | 5    | 3000 | 178.0              | 9.2                | 2.4     | 2.4     | 1.22    | 4.0     | 8.0    | Q3            |
| 74AHCT1G04DCKTG4 | SC70         | DCK             | 5    | 250  | 178.0              | 9.2                | 2.4     | 2.4     | 1.22    | 4.0     | 8.0    | Q3            |
| SN74AHCT1G04DBVR | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| SN74AHCT1G04DBVR | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.3     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| SN74AHCT1G04DBVR | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| SN74AHCT1G04DBVR | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.2                | 3.3     | 3.23    | 1.55    | 4.0     | 8.0    | Q3            |
| SN74AHCT1G04DBVT | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.2                | 3.3     | 3.23    | 1.55    | 4.0     | 8.0    | Q3            |
| SN74AHCT1G04DBVT | SOT-23       | DBV             | 5    | 250  | 180.0              | 8.4                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| SN74AHCT1G04DBVT | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.3     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| SN74AHCT1G04DBVT | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| SN74AHCT1G04DCKR | SC70         | DCK             | 5    | 3000 | 180.0              | 8.4                | 2.47    | 2.3     | 1.25    | 4.0     | 8.0    | Q3            |
| SN74AHCT1G04DCKR | SC70         | DCK             | 5    | 3000 | 178.0              | 9.0                | 2.4     | 2.5     | 1.2     | 4.0     | 8.0    | Q3            |
| SN74AHCT1G04DCKR | SC70         | DCK             | 5    | 3000 | 178.0              | 9.0                | 2.4     | 2.5     | 1.2     | 4.0     | 8.0    | Q3            |
| SN74AHCT1G04DCKR | SC70         | DCK             | 5    | 3000 | 178.0              | 9.2                | 2.4     | 2.4     | 1.22    | 4.0     | 8.0    | Q3            |
| SN74AHCT1G04DCKT | SC70         | DCK             | 5    | 250  | 178.0              | 9.2                | 2.4     | 2.4     | 1.22    | 4.0     | 8.0    | Q3            |
| SN74AHCT1G04DCKT | SC70         | DCK             | 5    | 250  | 178.0              | 9.0                | 2.4     | 2.5     | 1.2     | 4.0     | 8.0    | Q3            |

| Device           | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|-----|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74AHCT1G04DCKT | SC70         | DCK             | 5    | 250 | 178.0              | 9.0                | 2.4     | 2.5     | 1.2     | 4.0     | 8.0    | Q3            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| 74AHCT1G04DBVRG4 | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| 74AHCT1G04DBVTG4 | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| 74AHCT1G04DCKRG4 | SC70         | DCK             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| 74AHCT1G04DCKTG4 | SC70         | DCK             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| SN74AHCT1G04DBVR | SOT-23       | DBV             | 5    | 3000 | 202.0       | 201.0      | 28.0        |
| SN74AHCT1G04DBVR | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| SN74AHCT1G04DBVR | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| SN74AHCT1G04DBVR | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| SN74AHCT1G04DBVT | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| SN74AHCT1G04DBVT | SOT-23       | DBV             | 5    | 250  | 202.0       | 201.0      | 28.0        |
| SN74AHCT1G04DBVT | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| SN74AHCT1G04DBVT | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| SN74AHCT1G04DCKR | SC70         | DCK             | 5    | 3000 | 202.0       | 201.0      | 28.0        |
| SN74AHCT1G04DCKR | SC70         | DCK             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| SN74AHCT1G04DCKR | SC70         | DCK             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| SN74AHCT1G04DCKR | SC70         | DCK             | 5    | 3000 | 180.0       | 180.0      | 18.0        |

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| Device           | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|-----|-------------|------------|-------------|
| SN74AHCT1G04DCKT | SC70         | DCK             | 5    | 250 | 180.0       | 180.0      | 18.0        |
| SN74AHCT1G04DCKT | SC70         | DCK             | 5    | 250 | 180.0       | 180.0      | 18.0        |
| SN74AHCT1G04DCKT | SC70         | DCK             | 5    | 250 | 180.0       | 180.0      | 18.0        |



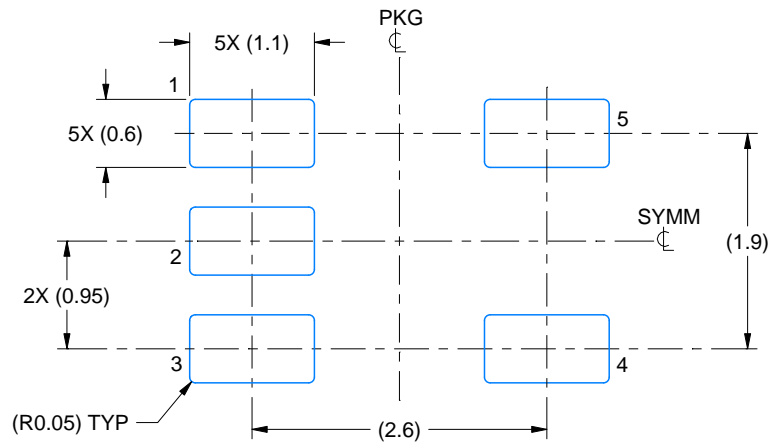


# EXAMPLE BOARD LAYOUT

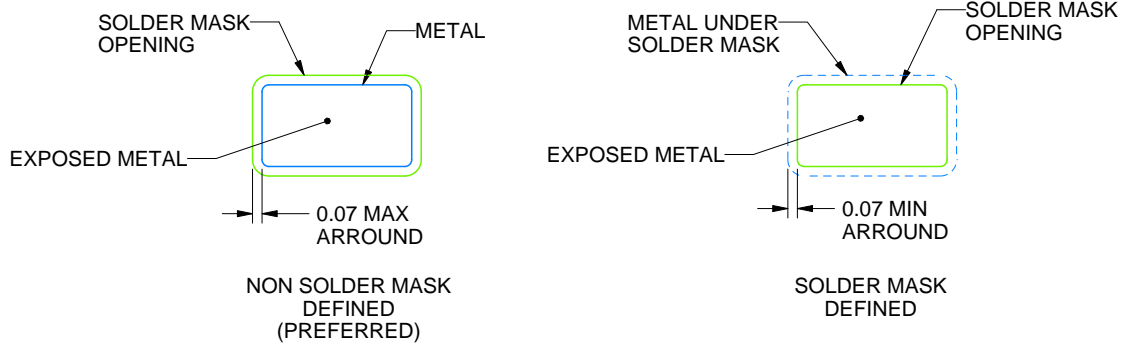
DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

4214839/E 09/2019

NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

4214839/E 09/2019

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

## DCK (R-PDSO-G5)

## PLASTIC SMALL-OUTLINE PACKAGE



4093553-3/G 01/2007

- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - Falls within JEDEC MO-203 variation AA.

DCK (R-PDSO-G5)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
  - D. Publication IPC-7351 is recommended for alternate designs.
  - E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.

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